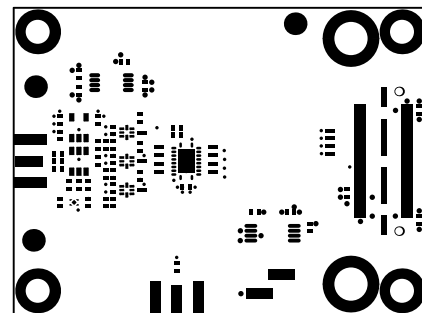
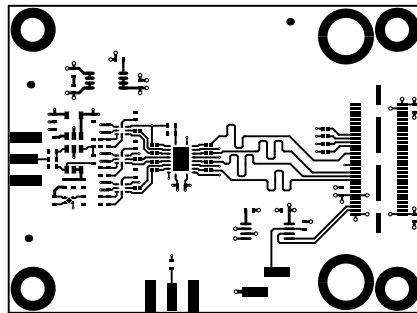


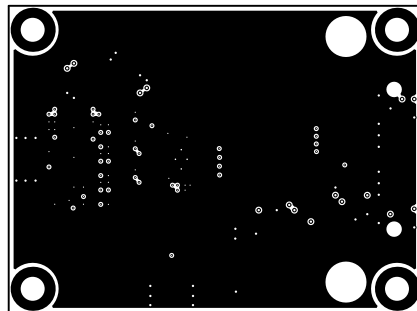
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01355	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Overlay	TID #: TIDA-01355		
PLOT NAME = Top Overlay	GENERATED : 8/3/2017	10:28:07 AM	TEXAS INSTRUMENTS



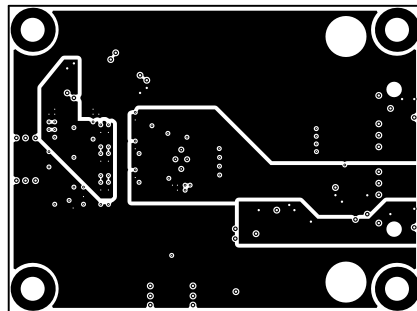
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01355	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Solder	TID #: TIDA-01355		
PLOT NAME = Top Solder Mask	GENERATED : 8/3/2017	10:28:08 AM	TEXAS INSTRUMENTS



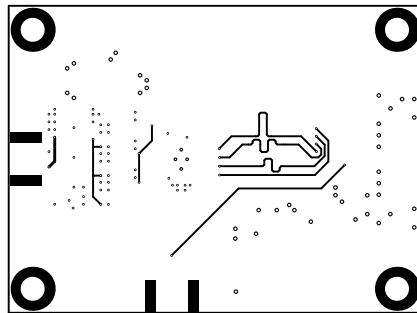
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01355	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Layer	TID #: TIDA-01355		
PLOT NAME = Top Layer	GENERATED : 8/3/2017	10:28:09 AM	TEXAS INSTRUMENTS



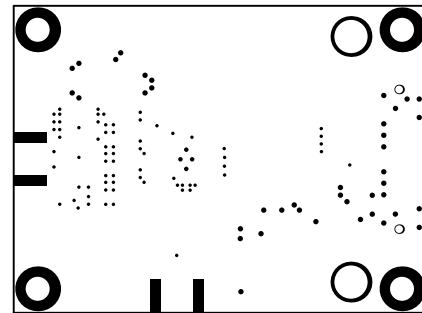
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01355	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = GND	TID #: TIDA-01355		
PLOT NAME =Signal Layer 1	GENERATED : 8/3/2017	10:28:10 AM	TEXAS INSTRUMENTS



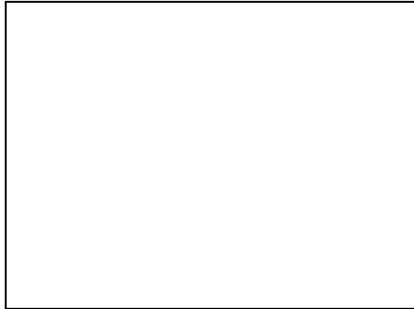
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01355	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = PWR	TID #: TIDA-01355		
PLOT NAME =Signal Layer 2	GENERATED : 8/3/2017	10:28:11 AM	TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01355	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Layer	TID #: TIDA-01355		
PLOT NAME =Bottom Layer	GENERATED : 8/3/2017	10:28:12 AM	TEXAS INSTRUMENTS

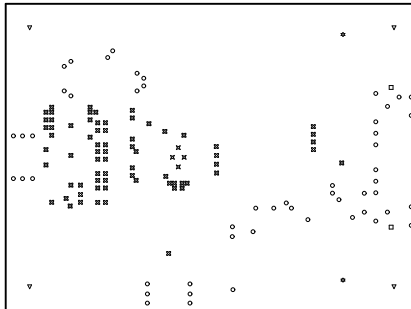


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01355	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder	TID #: TIDA-01355		
PLOT NAME =Bottom Solder Mask	GENERATED : 8/3/2017	10:28:12 AM	TEXAS INSTRUMENTS



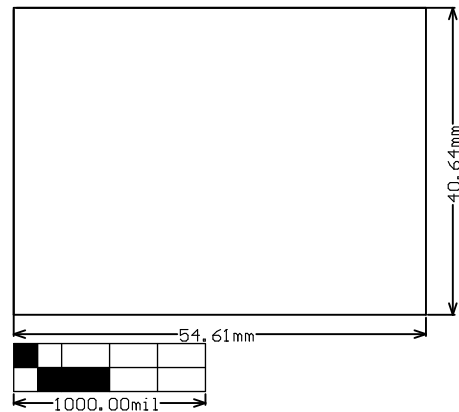
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01355	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Overlay	TID #: TIDA-01355		
PLOT NAME =Bottom Overlay	GENERATED : 8/3/2017	10:28:13 AM	TEXAS INSTRUMENTS





Symbol	Count	Hole Size	Plated	Hole Type
○	2	6.00mil (0.152mm)	NPTH	Round
○	4	7.874mil (0.200mm)	NPTH	Round
□	12	12.00mil (0.305mm)	NPTH	Round
⊗	1	7.87mil (0.200mm)	PTH	Round
▽	4	125.00mil (3.175mm)	PTH	Round
○	52	12.00mil (0.305mm)	PTH	Round
⊗	70	6.00mil (0.152mm)	PTH	Round
	134 Total			

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01355	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing	TID #: TIDA-01355		
PLOT NAME =Drill Drawing	GENERATED : 8/3/2017	10:28:14 AM	TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01355	REV: E1	SUN REV: Not In VersionControl
LAYER NAME =	TID #: TIDA-01355		
PLOT NAME =Board Dimensions	GENERATED : 8/3/2017	10:28:15 AM	TEXAS INSTRUMENTS

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